

First-principles Study of the Tritium Species Diffusion Across Ni-Zircaloy-4 Getter Interface



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Solutions for Today | Options for Tomorrow



Contributors of this Work

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 - Dr. Morgan Redington (summer intern)
- **PNNL**
 - Dr. David Senior
 - Dr. Andrew Casella

Disclaimer

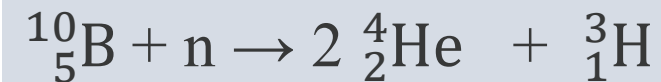
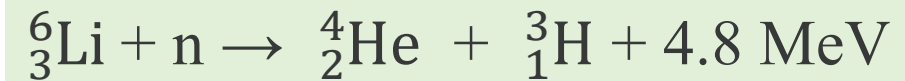


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Tritium & Its Application

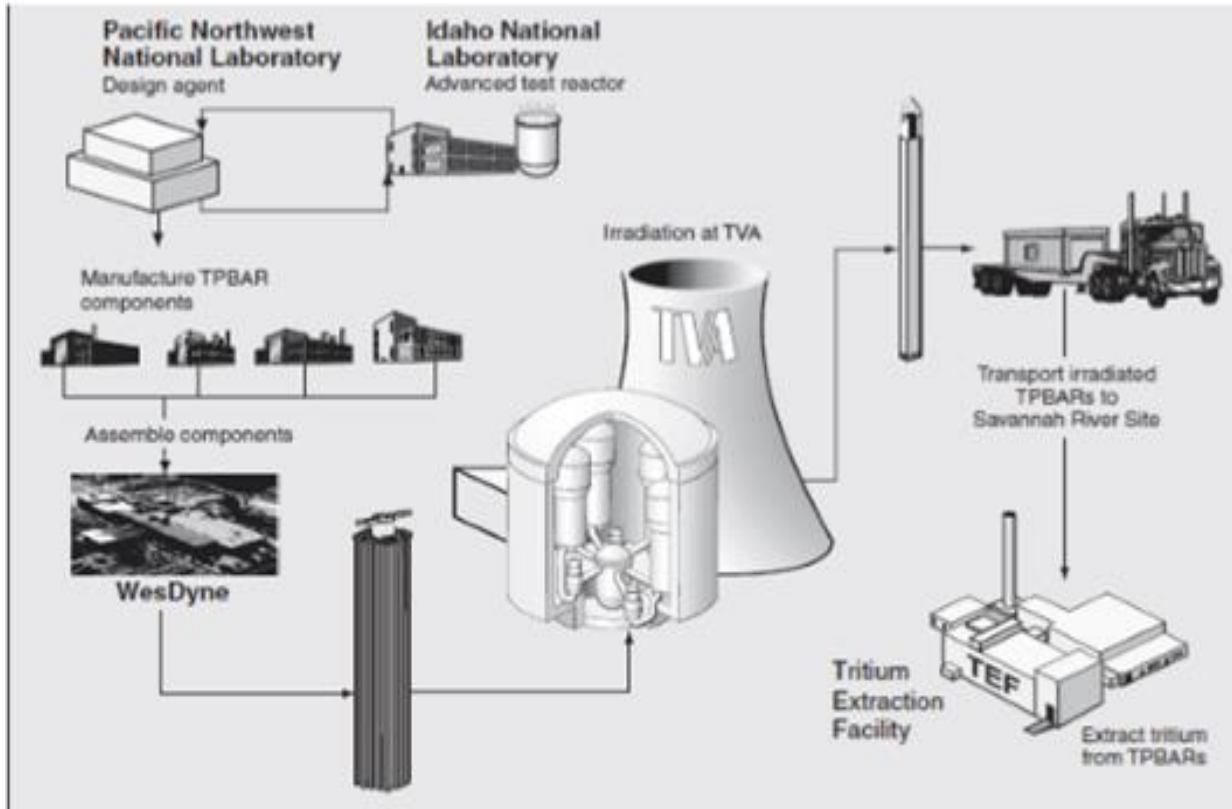
- Tritium is a radioactive isotope of hydrogen for commercial and military applications.
 - Tracer for chemical structures, geological water, medical diagnostics, sign illumination, vision device.
 - boost the yield of both fission and thermonuclear weapons
- Half-life of 12.3 years and low concentration (<20 kg) on Earth.
- So, to maintain certain amount of ^3H , we need to produce ^3H .

To produce tritium:

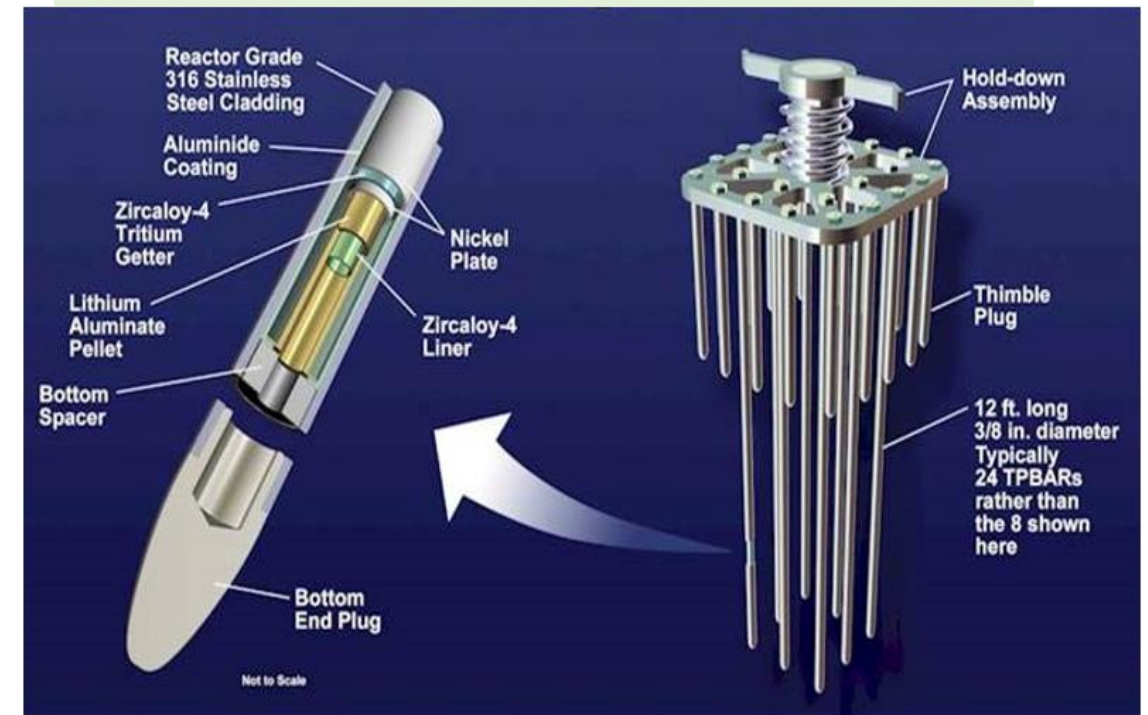
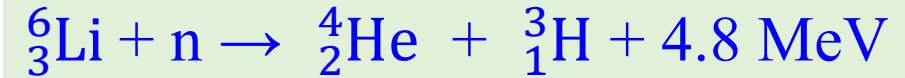


TPBAR producing tritium

DOE/NNSA's Tritium Modernization Program



Tritium-Producing Burnable Absorber Rod (TPBAR) in light water reactor to produce tritium through

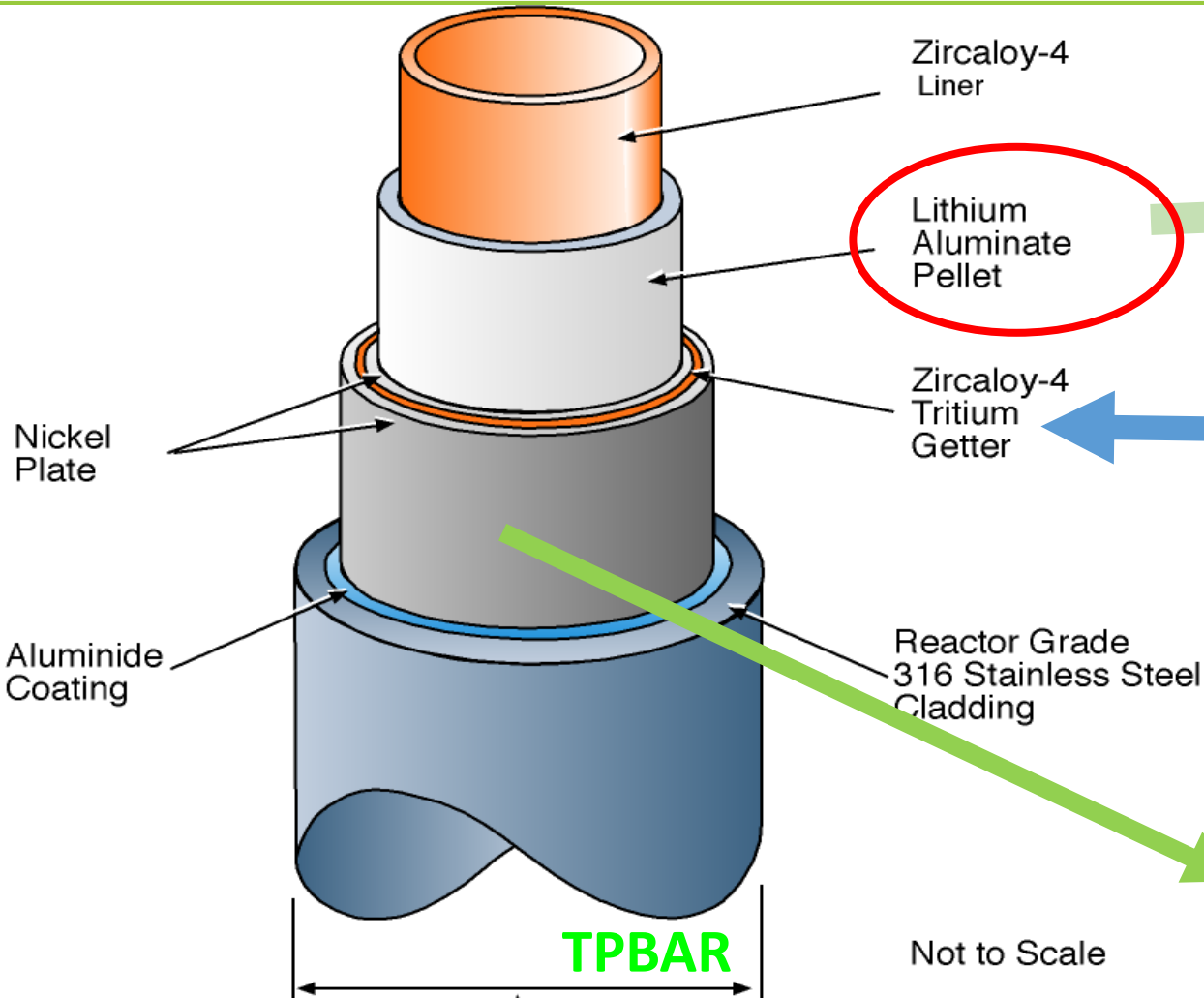


One TPBAR produces ~1.0 g ${}^3\text{H}_2$ over 1.5 years. Typically arranged in 17x17 array

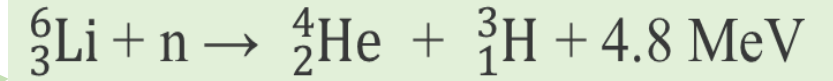
- Anderson, E. S., *et al*, PNNL-14401, (2003), doi:10.2172/15010654

- Senor, D.J., *Recommendations for Science and Technology in Support of the Tritium Sustainment Program*, PNNL-27216. 2017, PNNL

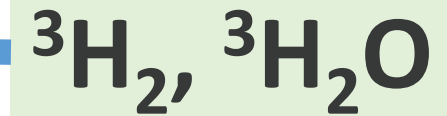
Tritium production from r-LiAlO₂ Pellet



We found



Main product



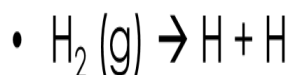
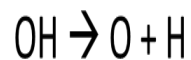
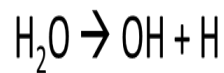
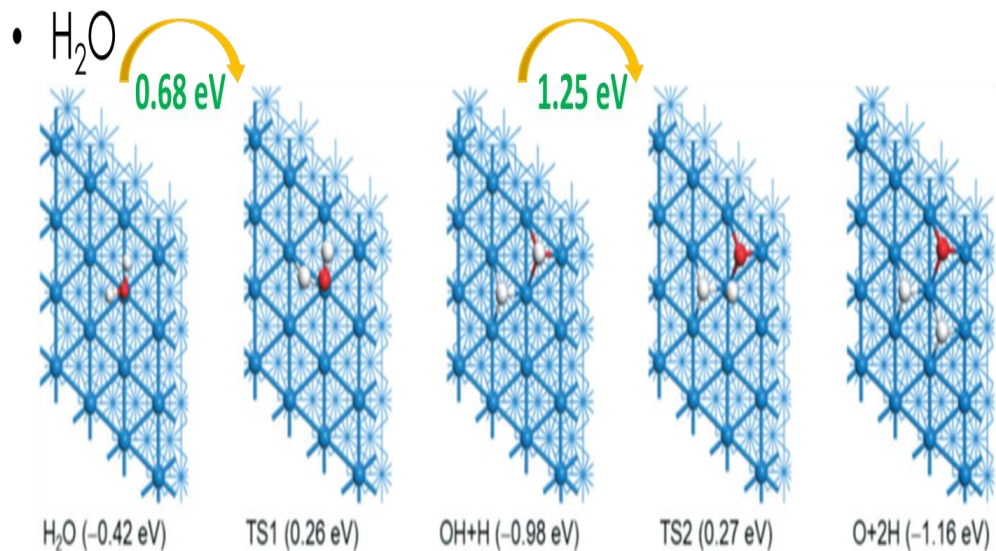
Now we focus on:

- T₂ & T₂O diffusion on nickel plate & across Ni-Zircalcoy-4 to form metal hydrides.
 - The role of Nickel Plate. Can the O stay in Ni layer to form NiO_x or Ni(O³H)_x?
 - ³H species get off the surface & diffusion into getter to form metal hydrides.
 - Impurity effects on ³H diffusion and metal hydrides formation.

- Paudel, *et al*, *Comput. Mater. Sci.* **181**(2020)109748; **193**(2021)110419; *J. Phys. Chem. C* **122**(2018)9755-65, 28447-5; **127**(2023)12435-43
- T. Jia, *et al*, *J. Nucl. Mater.* **555**(2021)153111; **540**(2020)152394, **522**(2019)1-10; *Appl. Surf. Sci. Adv.* **5**(2021)100114

T₂ or T₂O on Ni (111) Surface & subsurface

Literature review



Size	Method	E _a (eV)	E _r (eV)
4 x 4	PBE+vdW	0.09* (0.25ML)	-0.60
4 x 4	PBE+vdW	0.03** (0.125ML)	-0.75
4 x 4	PBE+vdW	0.13** (0.25ML)	-0.74

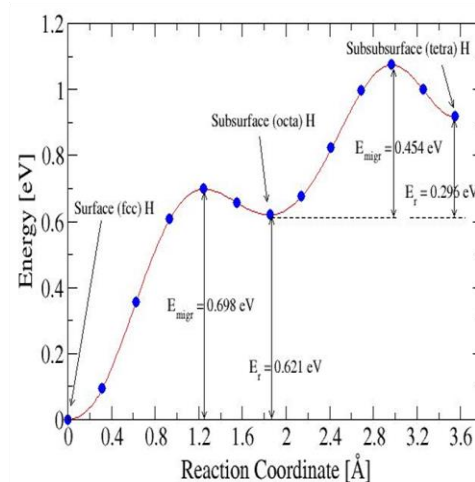
Zhu et al. Catal. Sci. Technol. 2019, **9**, 199.
 Shirazi et al. Phys. Chem. Chem. Phys. 2017, **19**, 19150.

*Both H-atoms located at the fcc and hcp sites adjacent to each other. **fcc and hcp sites opposite to each other.

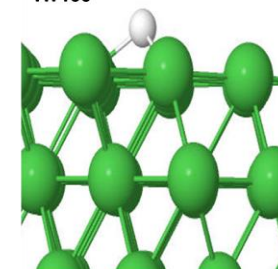
Our focus:

- If O can stay in the Ni layer to form NiO_x or Ni(OH)_x
- Only ³H pass through Ni layer to get into Getter to form metal hydrides.

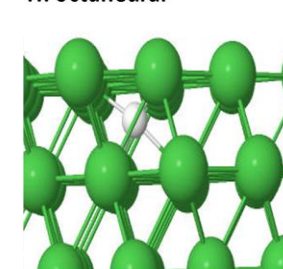
Diffusion of H from Ni(111) surface to bulk



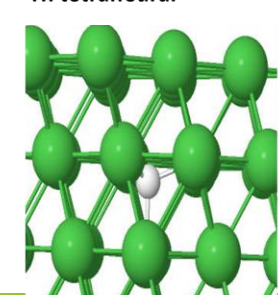
H: fcc



H: octahedral



H: tetrahedral



White: H
 Green: Ni
 Red : O

Chemical Potential Domains for Ni(OH)₂

Thermodynamic Basis

- Stability requires smaller atomic chemical potential than corresponding elemental solid, i.e., $\mu_i \leq \mu_i^{solid/gas}$

and

$$\Delta\mu_{Ni} + 2\Delta\mu_O + 2\Delta\mu_H = \Delta H(Ni(OH)_2)$$

$$\Delta\mu_i = \mu_i - \mu_i^{solid/gas}$$

$$\Delta\mu_i \leq 0, \quad i = Ni, O, H$$

- Constraints on $\Delta\mu_i$ to avoid the formation of other competing phases considering the existing solids NiO, Ni₂O₃, Ni₃O₄, NiO₂, NiOOH

$$\Delta\mu_{Ni} + \Delta\mu_O \leq \Delta H(NiO)$$

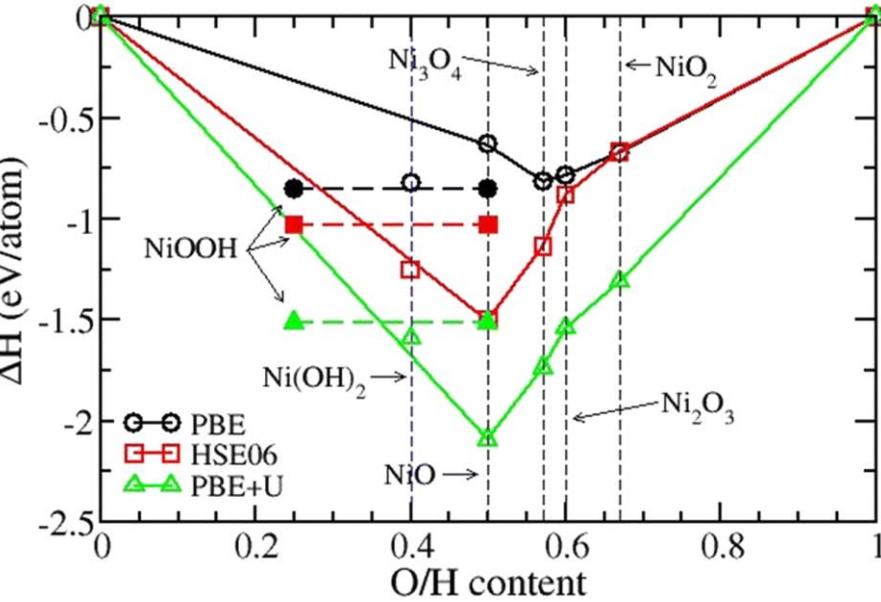
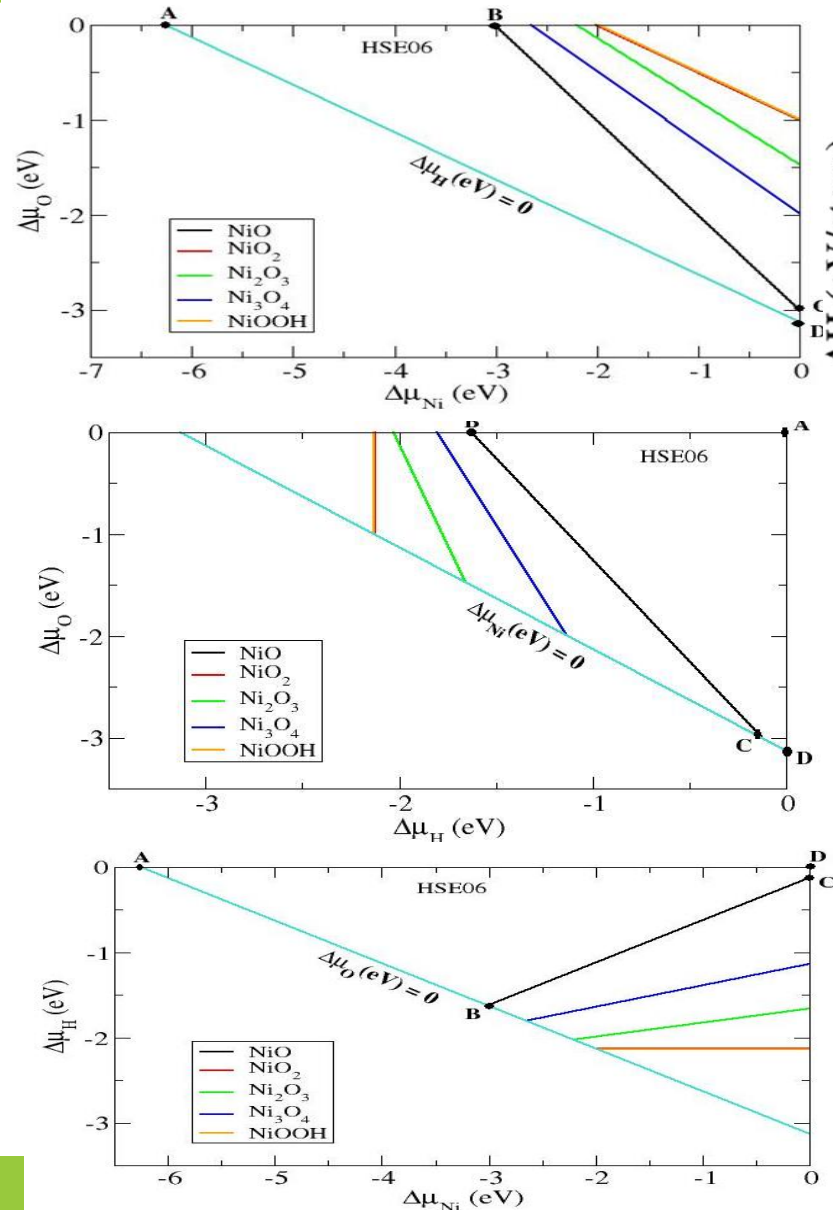
$$\Delta\mu_{Ni} + 2\Delta\mu_O \leq \Delta H(NiO_2)$$

$$2\Delta\mu_{Ni} + 3\Delta\mu_O \leq \Delta H(Ni_2O_3)$$

$$3\Delta\mu_{Ni} + 4\Delta\mu_O \leq \Delta H(Ni_3O_4)$$

$$\Delta\mu_{Ni} + 2\Delta\mu_O + \Delta\mu_H \leq \Delta H(NiOOH)$$

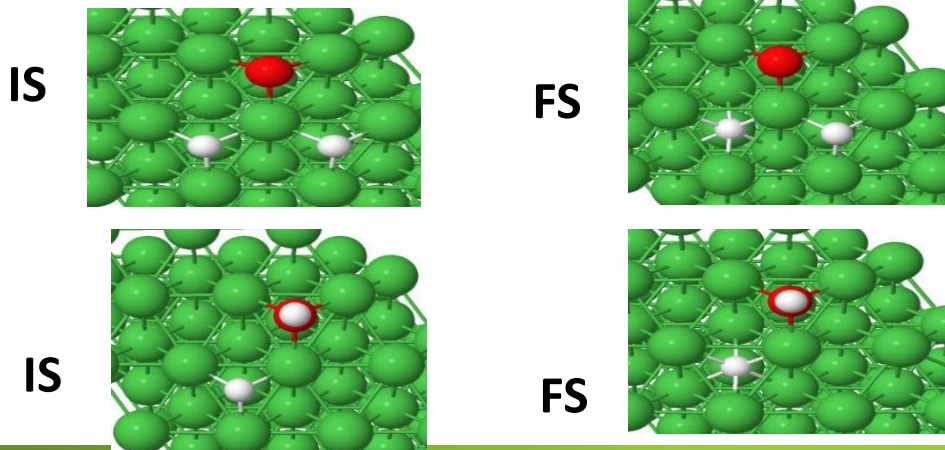
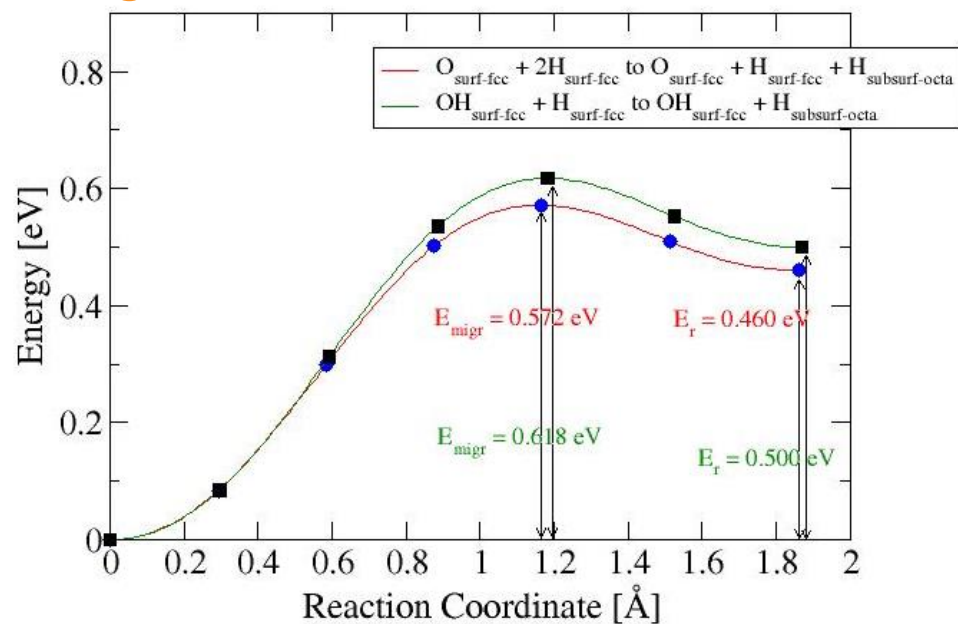
- Tafen, *et al*, **PCCP** **27**(2025)481-489
- Redington, *et al*, **PCCP** **27**(2025)7893-7904



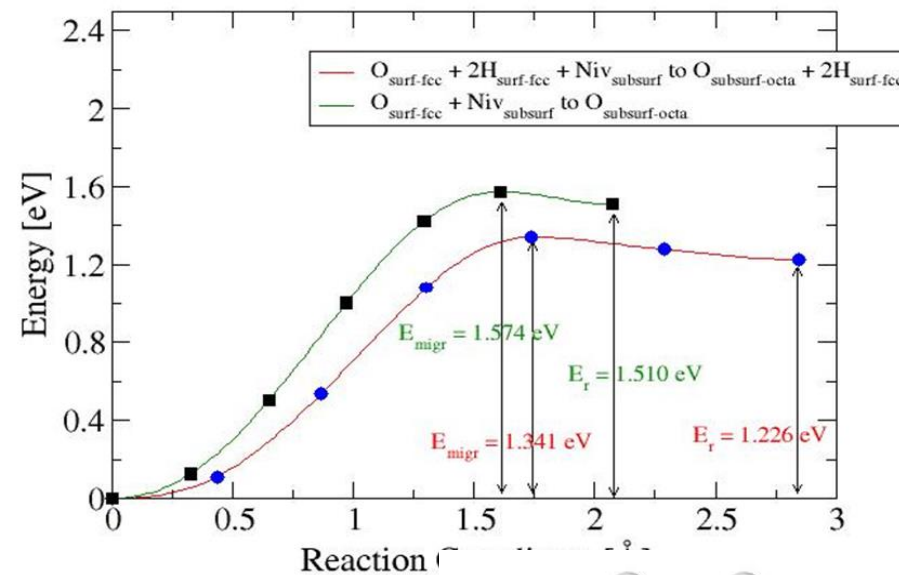
- Stable chemical potential region of the bulk Ni(O³H)₂ in terms of the chemical potentials $\Delta\mu_O, \Delta\mu_{Ni}$, and $\Delta\mu_H$ using PBE functional.
- Points A, B, C, and D define the limiting stable conditions, the allowed chemical potential range for Ni(O³H)₂ to be a stable phase.

H and O Diffusion thru Ni(111) Surface

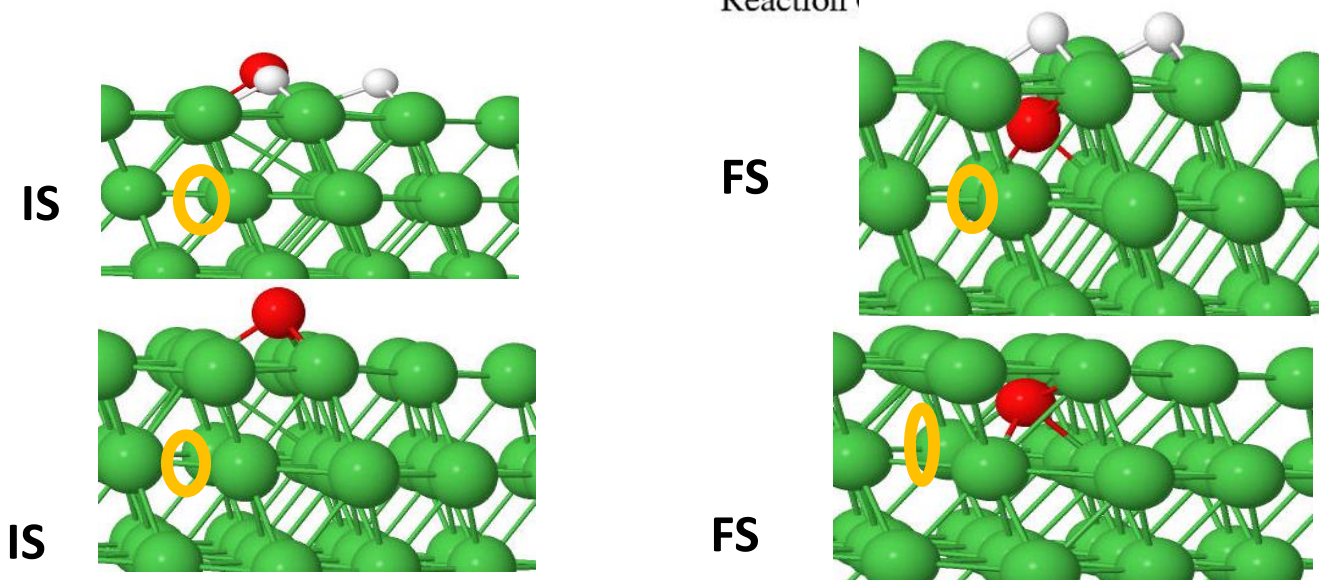
H migration from surface to subsurface



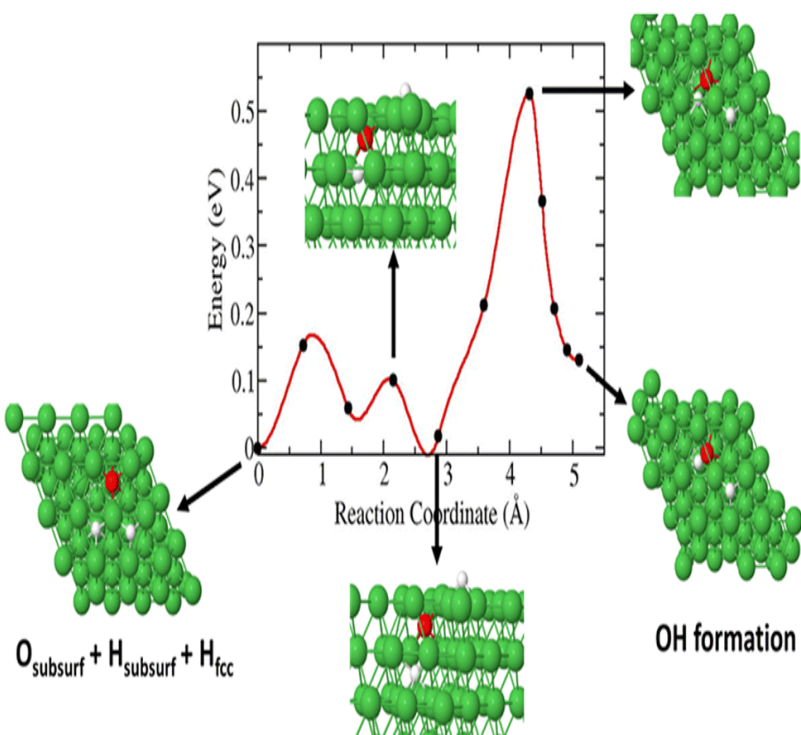
O migration from surface to subsurface



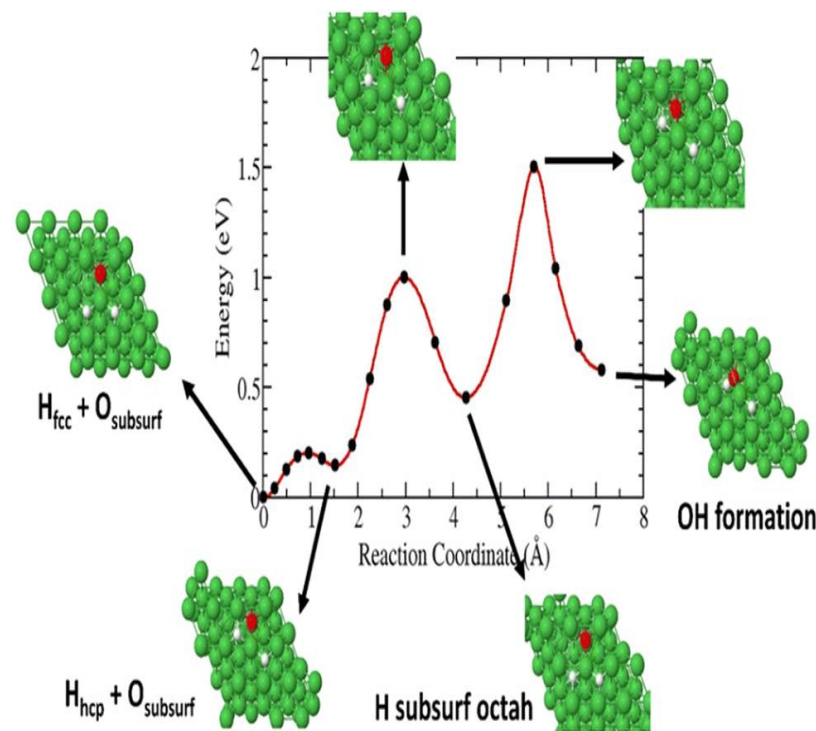
= Niv, Ni vacancy



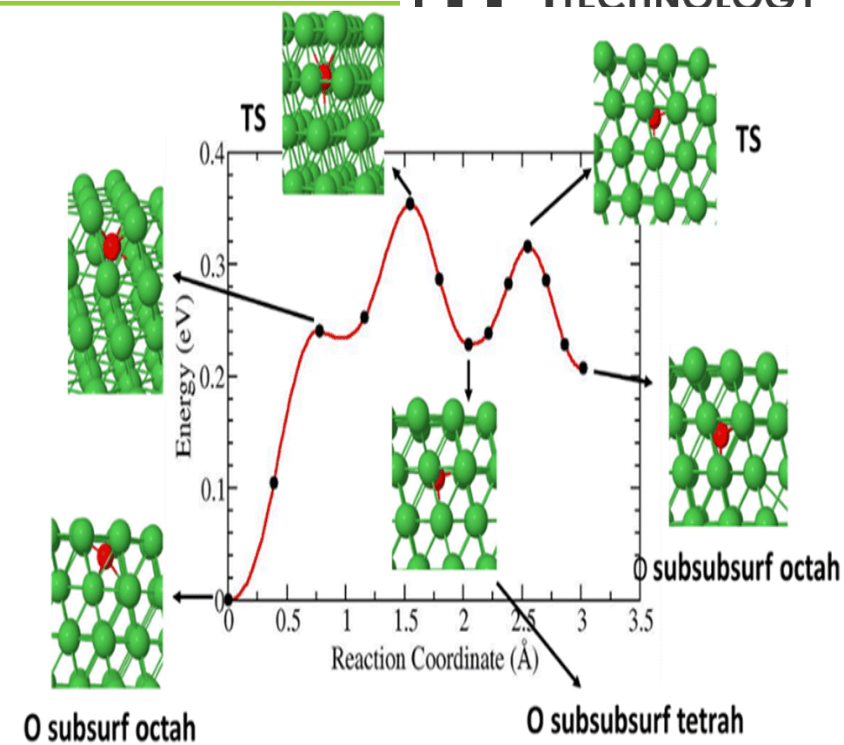
Formation of Ni(O³H)_x



through diffusion of a subsurface H species



through diffusion of a surface ³H species



O species from a subsurface octahedral to a sub-subsurface octahedral.

Preliminary results:

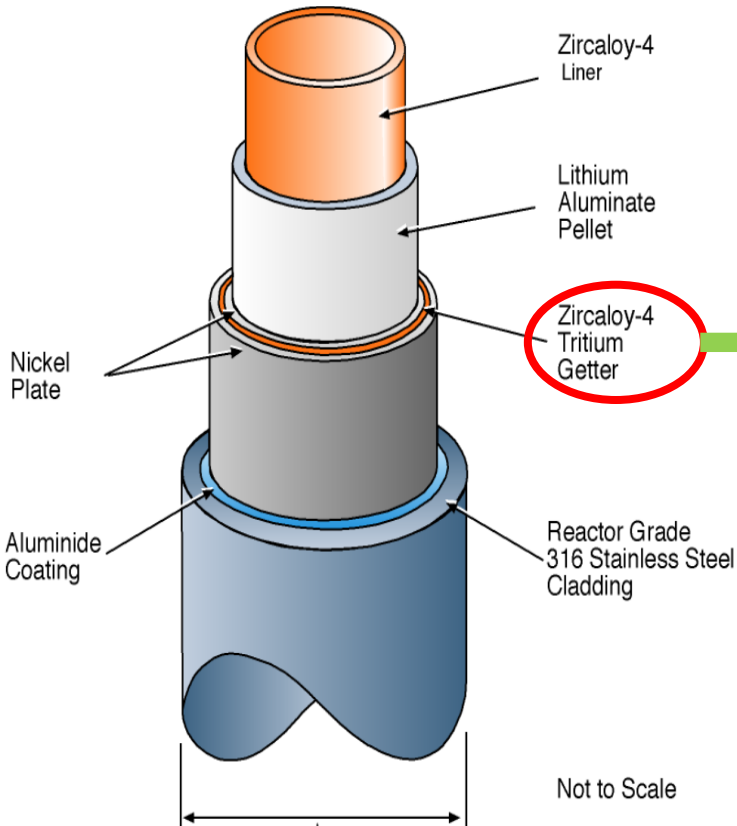
- Tafen, *et al*, **PCCP** 27(2025)481-489; Redington, *et al*, **PCCP** 27(2025)7893-7904

- ³H is much easier to diffuse from surface to sub-surface than O;
- O prefers to diffuse into V_{Ni} site to form NiO_x or Ni(O³H)_x due to its high diffusion energy barrier compared to that of ³H;
- Formation of NiO_x or Ni(O³H)_x phase in Ni subsurface layer is limited by O diffusion energy barrier and Ni vacancy defects.

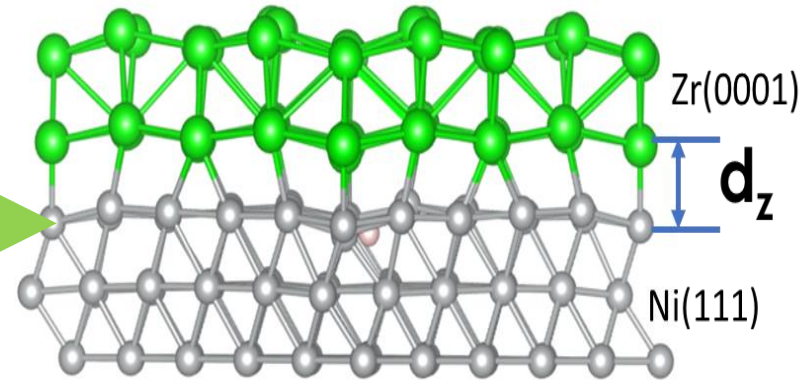
Zr/Ni Interface models

Ni(111)/Zr(0001) interfaces and model optimization

Interface Optimization



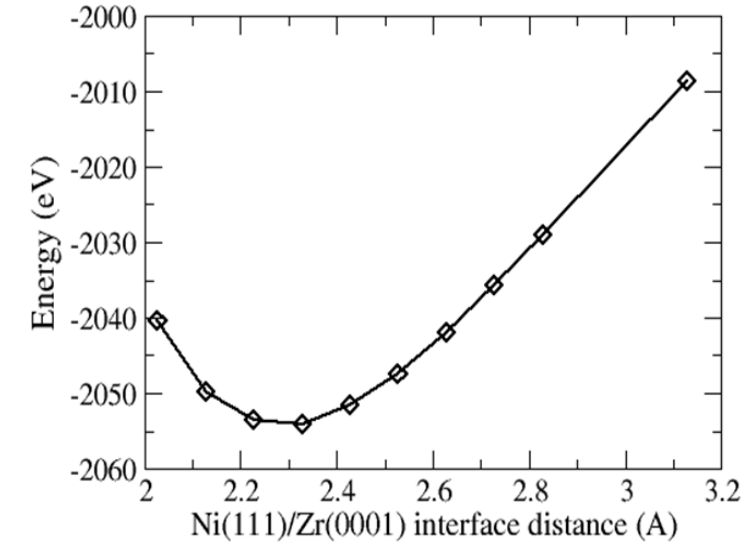
Five-layer Ni()/Zr interface model



$$5 \times 2.457 = 12.28 \text{ \AA}$$

$$4 \times 3.170 = 12.68 \text{ \AA}$$

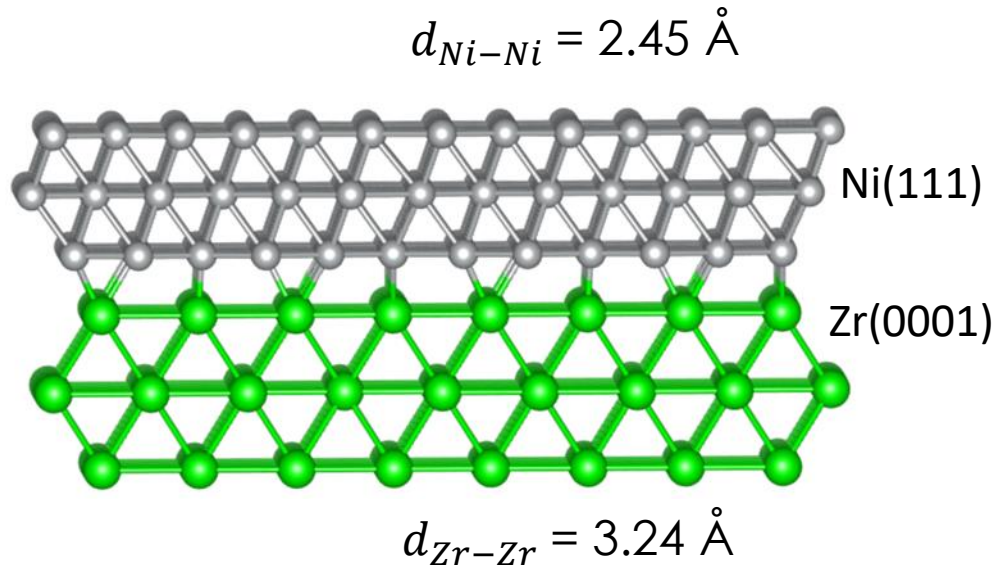
$$\text{New ratio } a_{\text{Ni}}^*/a_{\text{Zr}}^* = 1.032$$



$$d_{opt} = 2.32 \text{ \AA}$$

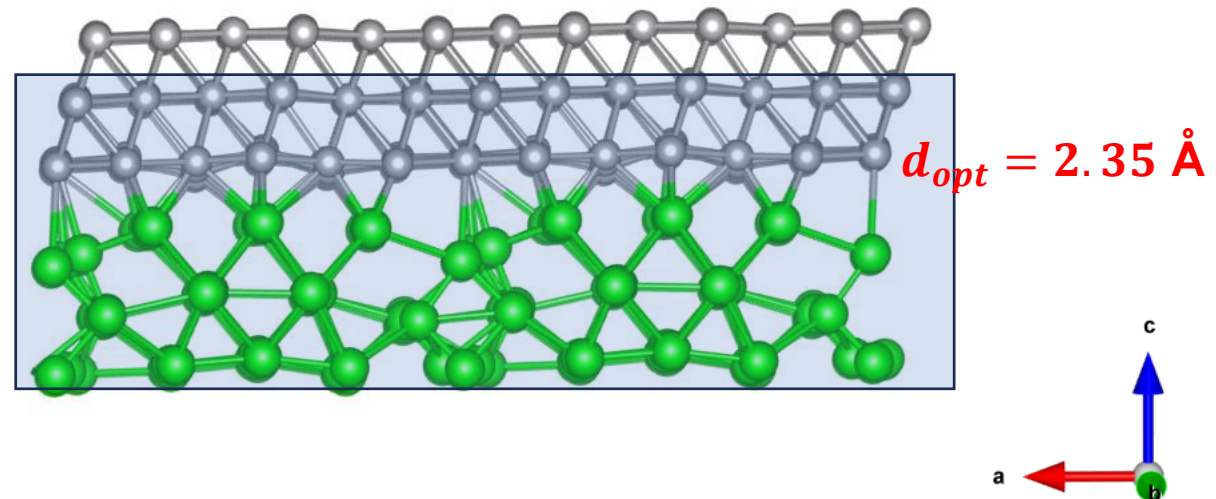
Ni(111)/Zr(0001) Interface model

Six layers Ni(111)Zr(0001) interface model



On Ni side:

- Bond distance varies $d_{Ni-Ni} = 2.5-2.65 \text{ \AA}$
- More displacement along a-axis
- Minimal displacement along c-axis



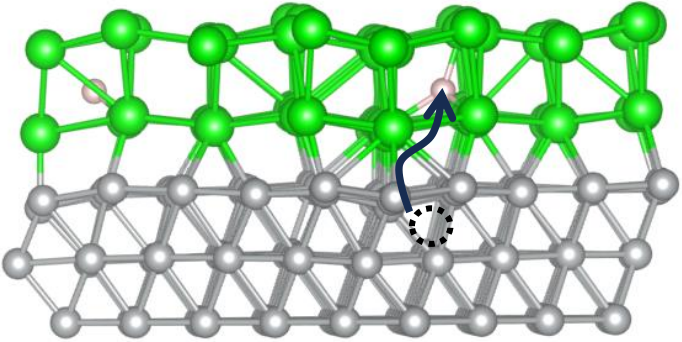
On Zr side:

- More displacement along a-axis
- Boundary atoms are more displaced
- Displacement of some atoms by more than an Å.

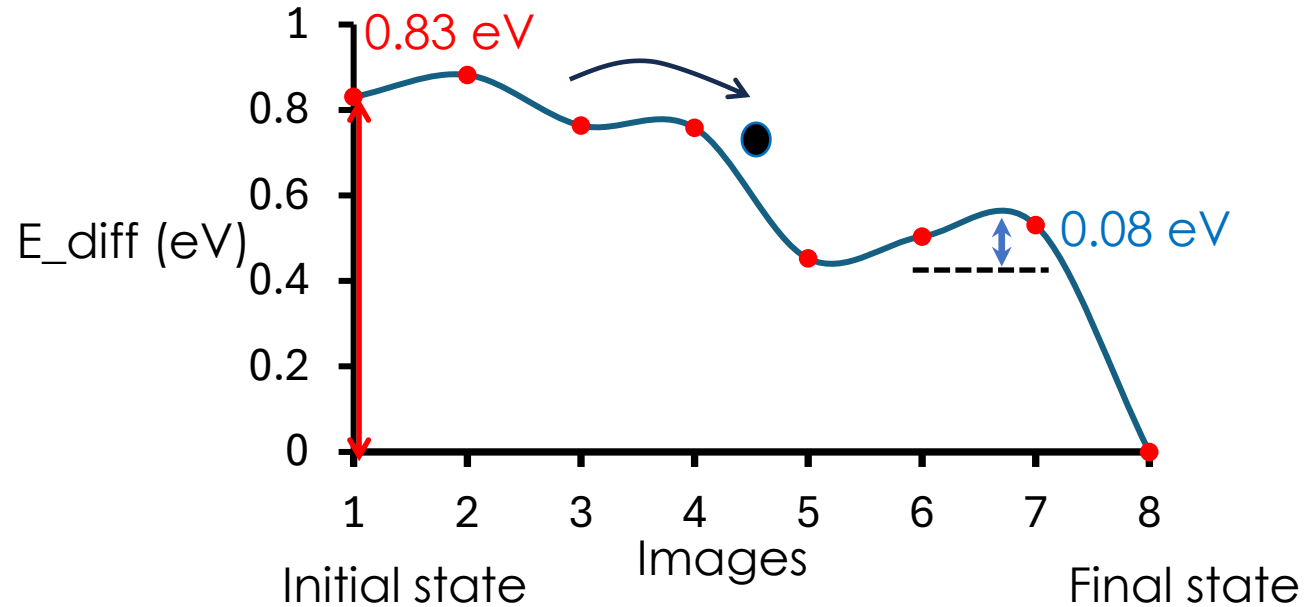
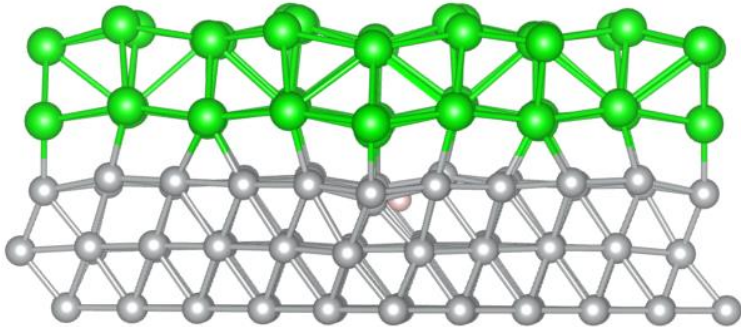
Ni(111)/Zr(0001) Interface model

Tritium diffusion across Ni(111)/Zr(0001) Interface

Final state



Initial State

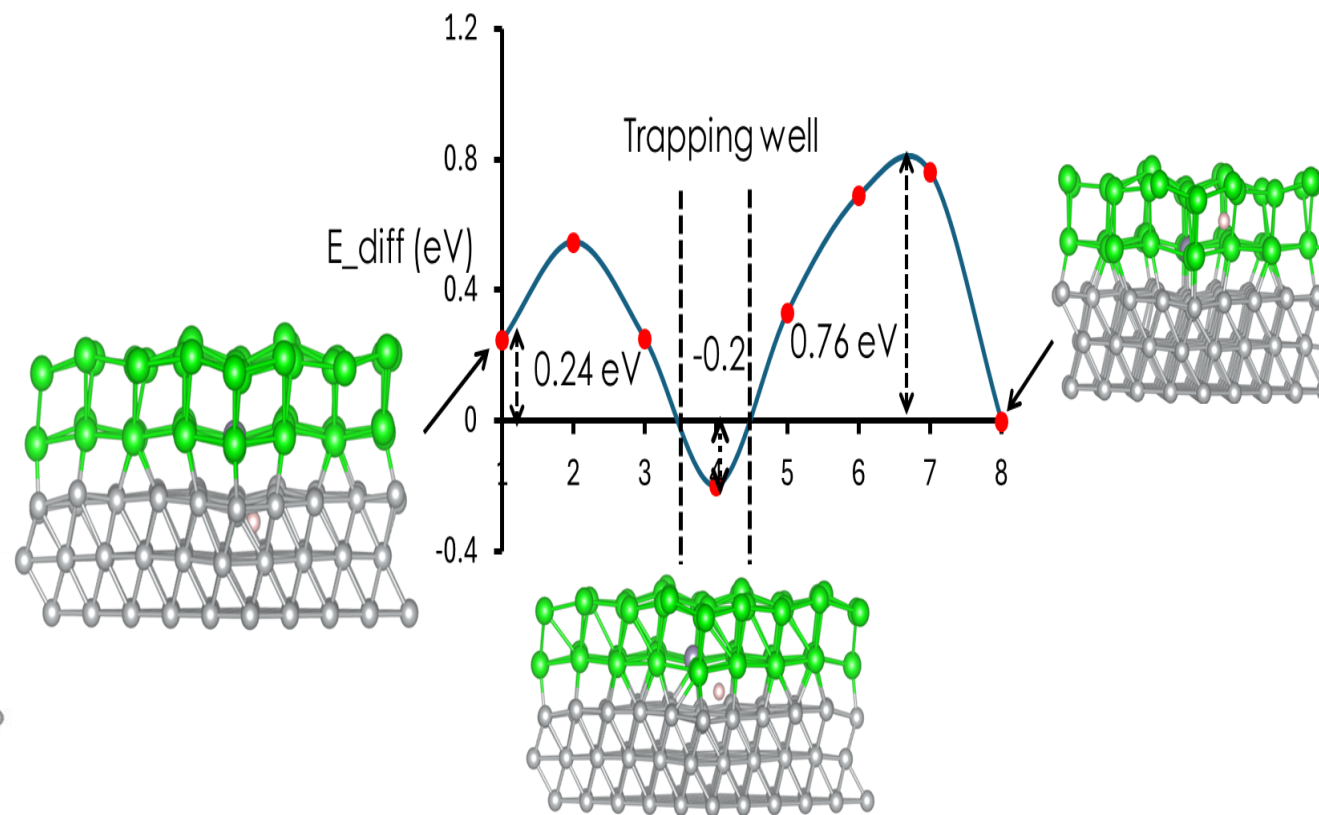
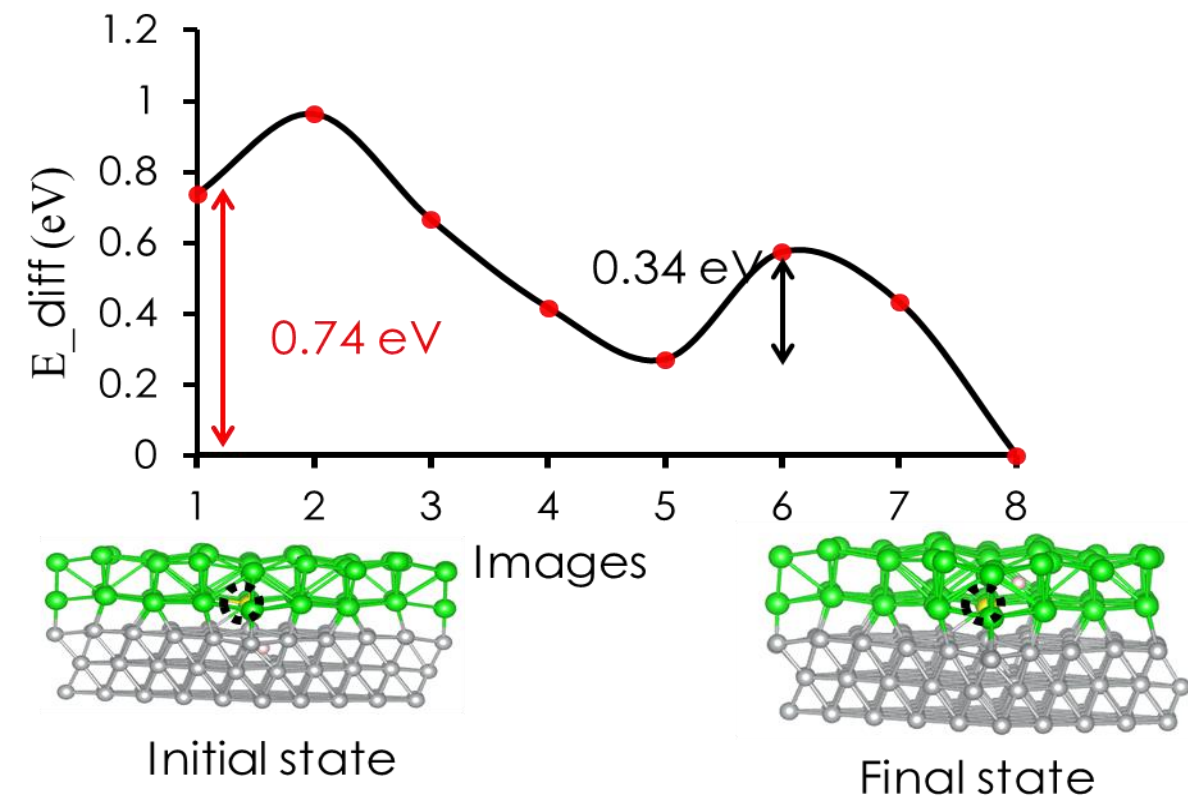


Zr (0001) site for ^3H is 0.83 eV lower than Ni (111) site.

Ni(111)/Zr(0001) Interface model

Tritium diffusion across Ni(111)/Zr(0001) Interface: With one Zr vacancy

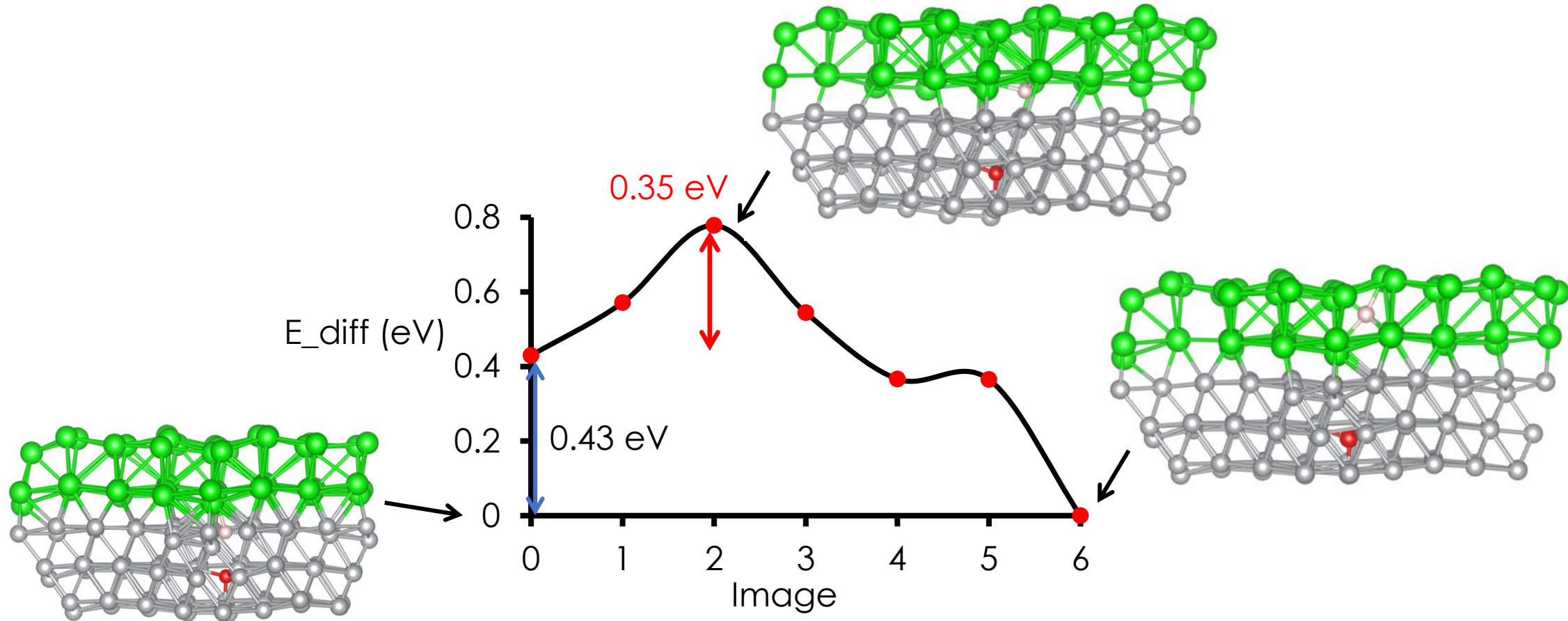
Tritium diffusion across Ni(111)/Zr(0001) Interface: With a Sn impurity



With a Sn impurity, small ^3H trapping well was found at the interface.

Ni(111)/Zr(0001) Interface model

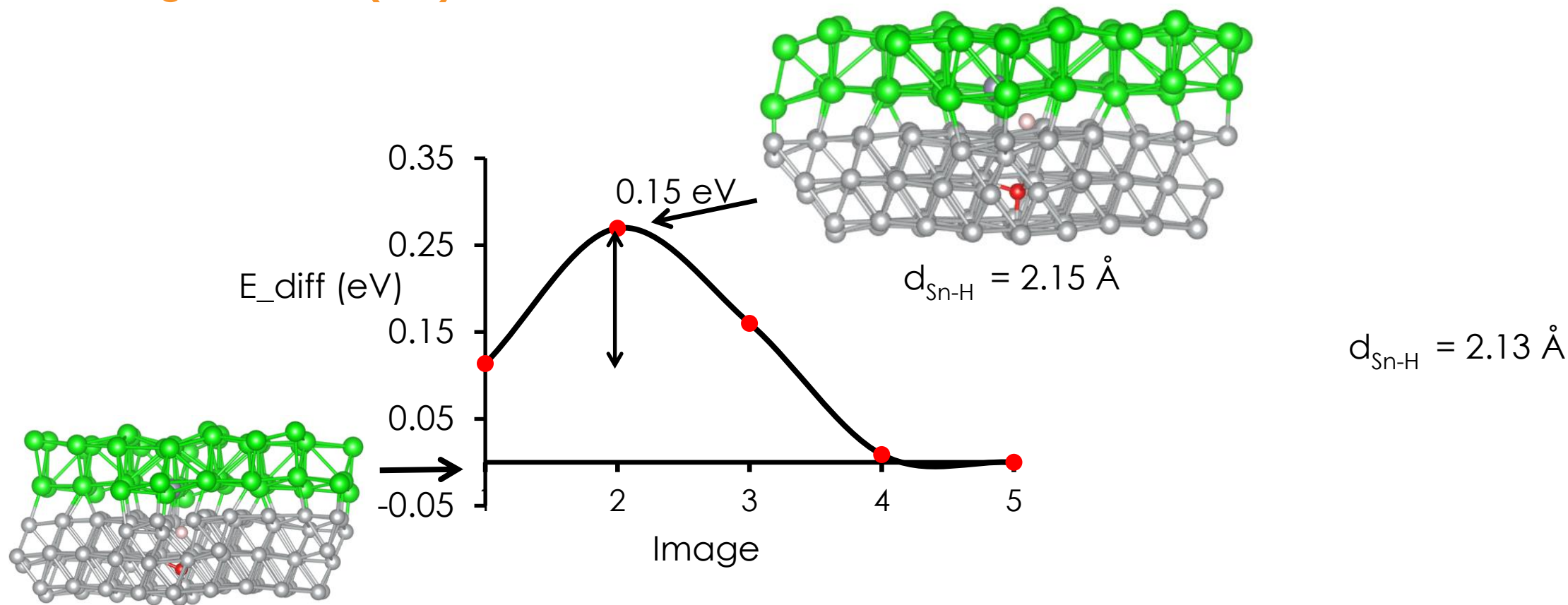
Introducing Ni(OH) at the interface: Diffusion of ^3H



Initial energy barrier height for tritium diffusion in presence of O in Ni (111) was found to be 0.35 eV, almost 0.25 eV higher than with no O impurity but ^3H is more stable by 0.43 eV in Zr region.

Ni(111)/Zr(0001) Interface model

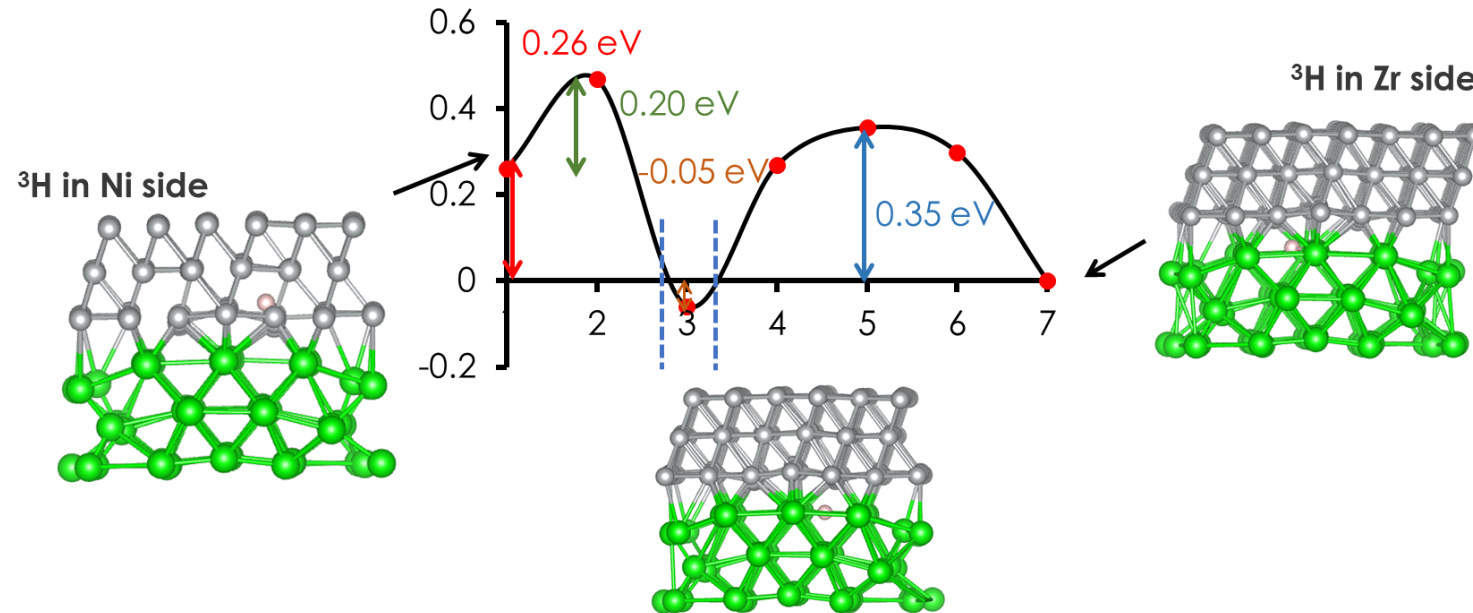
Introducing Sn and Ni(OH) at the interface: Diffusion of ^3H



The ^3H stability in Zr region is reduced by 0.2 eV with Sn and Ni(OH) as compared to with Ni(OH) only.

Ni (111)/Zr (0001) Interface Model

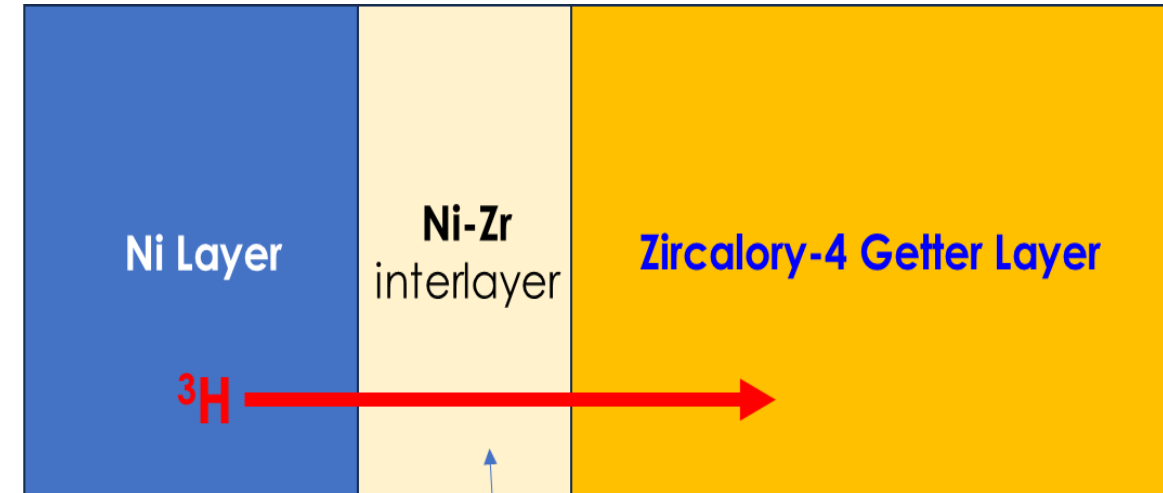
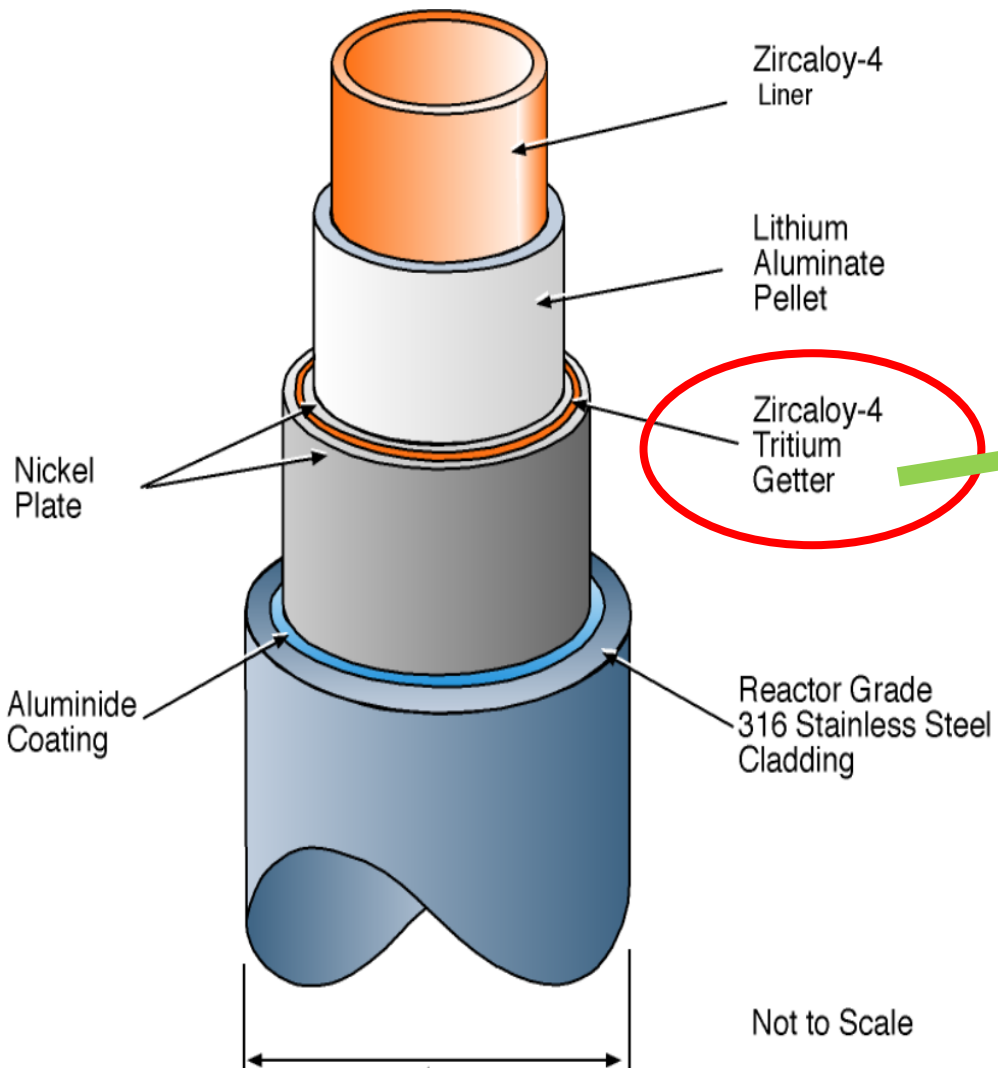
Tritium Diffusion Across Ni (111)/Zr (0001) Interface



³H is more stable by 0.26 eV in Zr region than in Ni.

- In Ni/Zr interface model, ³H was found to be relatively more stable by 0.83 eV in Zr (0001) region than Ni (111) region.
- Initial energy barrier height for tritium diffusion in presence of O in Ni (111) was found to be 0.35 eV, almost 0.25 eV higher than with no O impurity but ³H was more stable by 0.43 eV in Zr region.
- The ³H stability in Zr region was reduced by 0.2 eV with Sn and Ni(OH) as compared to with Ni(OH) only.

Ni/ZrNi/Zr Getter Model



Simulation models:

Ni-NiZr_x interface
Bulk
NiZr_y-Zi interface

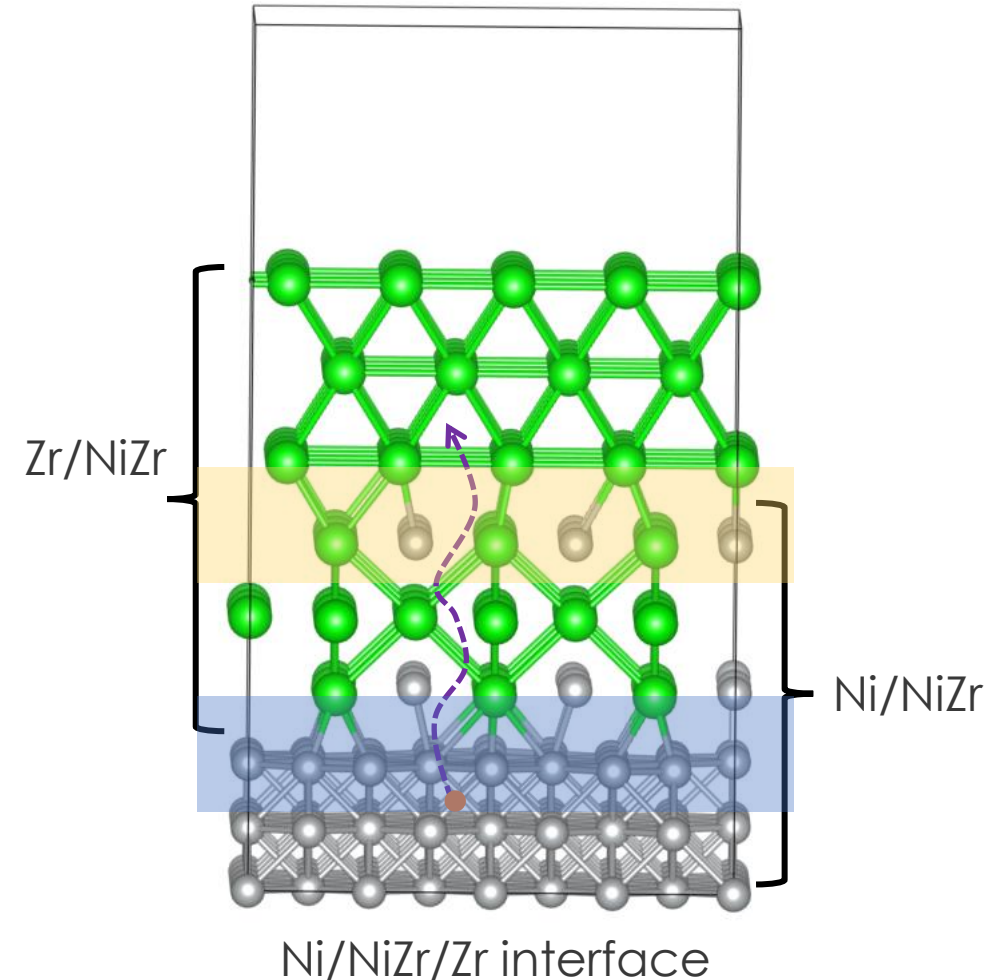
Ni/NiZr/Zr Alloy Interface Modeling

Objective

- Calculate the solubility and diffusion behavior for T at the Ni/NiZr/Zr interface.

Challenges

- Design two interface models: Ni/NiZr and NiZr/Zr.
- Adsorption and diffusion of T across the complex interfaces.

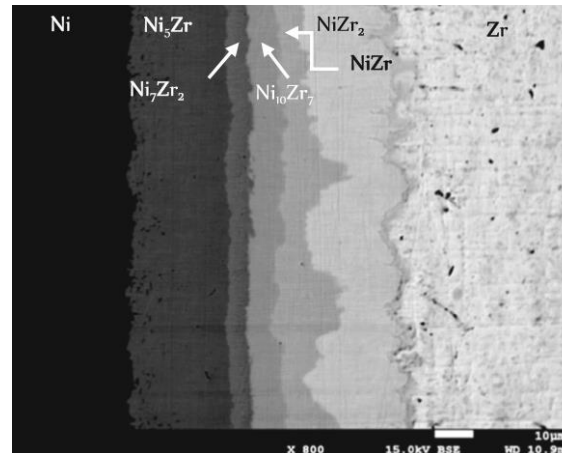


Ni/Zr Alloy Complex Interface Development

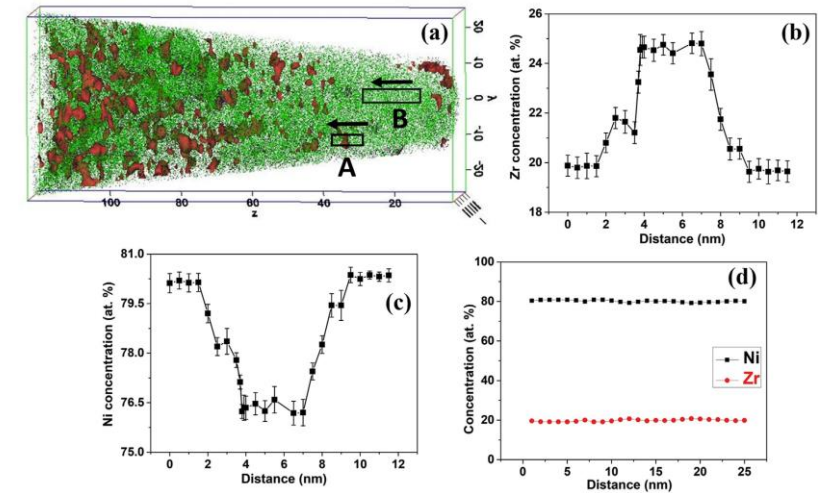
Simple Toy Model for Ni (111)/Zr (0001) Interface

Ni-Ni bond length = 2.457 \AA
Zr-Zr bond length = 3.170 \AA

- Five intermetallic compounds, Ni_5Zr , Ni_7Zr_2 , $\text{Ni}_{10}\text{Zr}_7$, NiZr , and NiZr_2 are found to grow in the interdiffusion zone.
- Activation energy is found to be lowest for $\text{Ni}_{10}\text{Zr}_7$ ($178 \pm 8 \text{ kJ/mol}$) and highest for NiZr ($323 \pm 6 \text{ kJ/mol}$).
- In amorphous NiZr , smaller atoms are the predominant diffusing species.



Back-scattered electron (BSE) image of the interdiffusion zone.



TEM images and concentration profile for microstructure evolution of the as-deposited film; the energy dispersive X-ray spectroscopy (EDXS) spectrum showing the Ni and Zr elements.

Journal of Alloys and Compounds 844 (2020) 156078.
Journal of Phase Equilibria and Diffusion 36, 4, 2015.

Experimental Facts on NiZr Interface

Modeling of Binary Intermetallic Compound $\text{Ni}_{0.5}\text{Zr}_{0.5}$

- Ordered $\text{Ni}_{0.5}\text{Zr}_{0.5}$ and $\text{Ni}_{0.33}\text{Zr}_{0.67}$ intermetallic compounds indicate that amorphization may be initiated by destroying the long-range order in the system by introduction of antisite defects.
- It is in fact possible to fabricate the “metallic glass” (solid alloys that are non-crystalline and have a glass-like structure) over a wide continuous range from $\text{Ni}_{0.2}\text{Zr}_{0.8}$ to $\text{Ni}_{0.3}\text{Zr}_{0.7}$ above the crystallization temperature T_c .
- The sharp drop in T_c for the Zr-rich alloy $\text{Ni}_{20}\text{Zr}_{80}$ is due to the formation of the high-pressure ω -Zr phase.

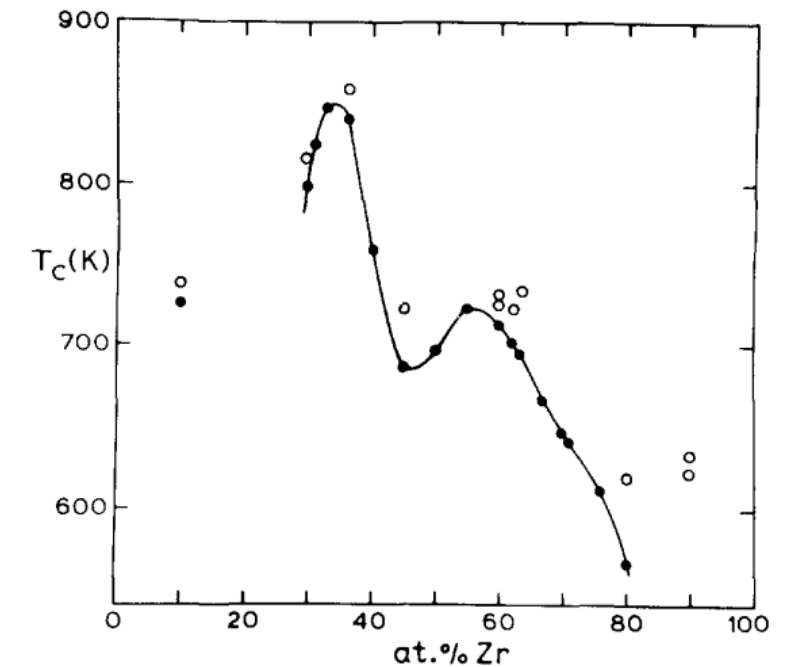
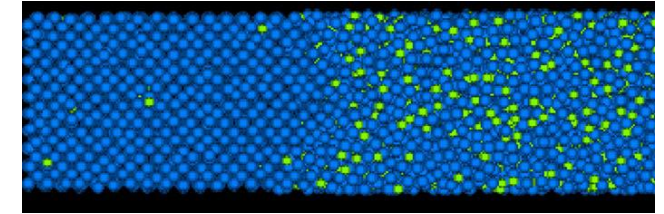
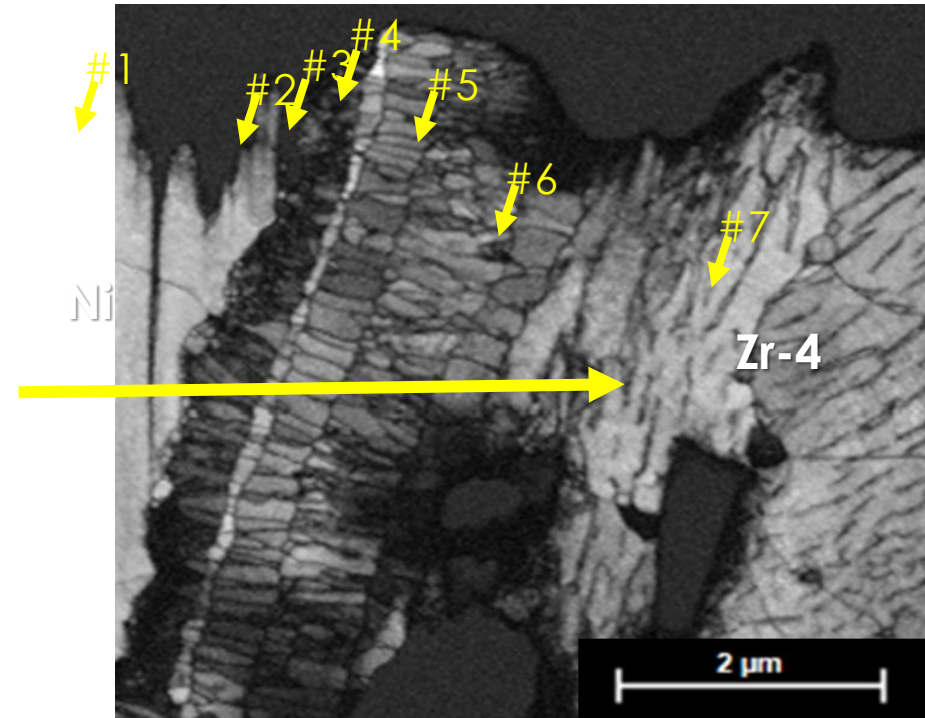
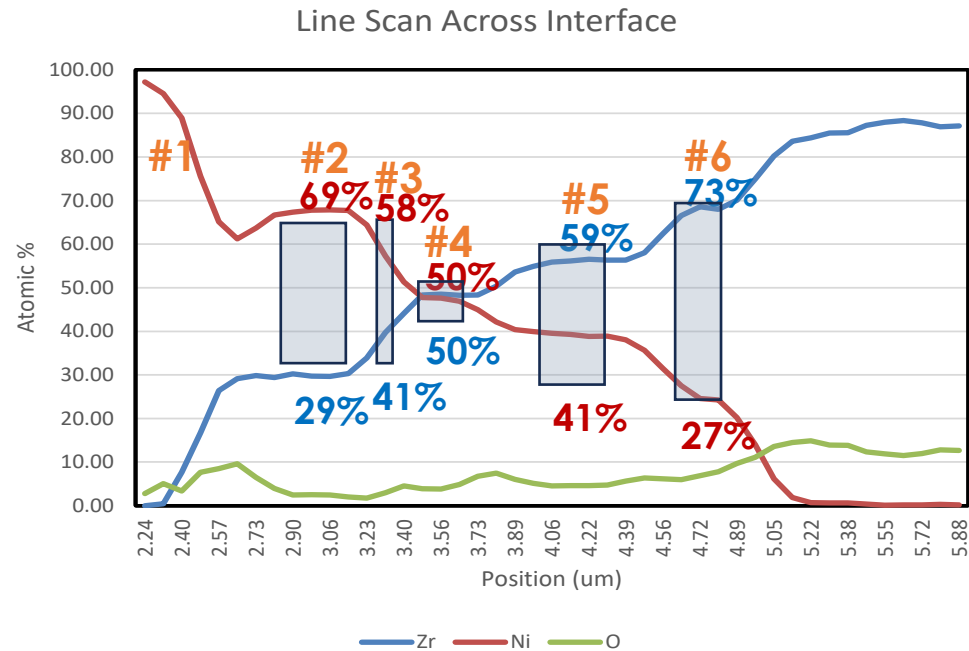


FIG. 2. The crystallization temperatures (solid circles) for Ni-Zr taken from DSC measurements at 10 K/min heating rate. The open circles give the temperatures of subsequent peaks in the DSC scan.

- Altounian, Z.; Guo-hua, T., *J Appl Phys* 1983, **54** (6), 3111-3116.

Experimental Facts on Ni_xZr_{1-x} Interface

Information Provided by PNNL



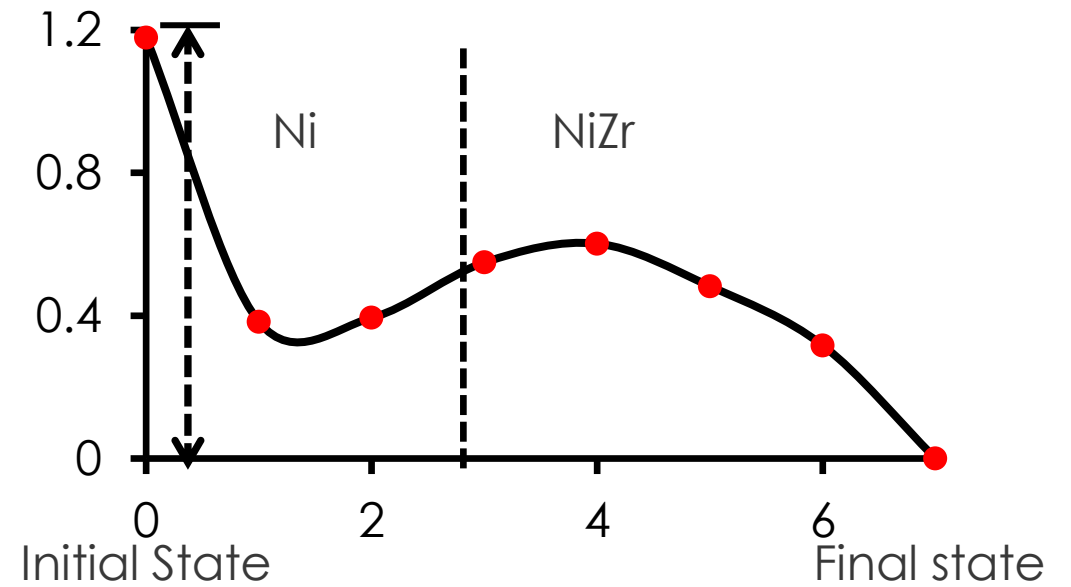
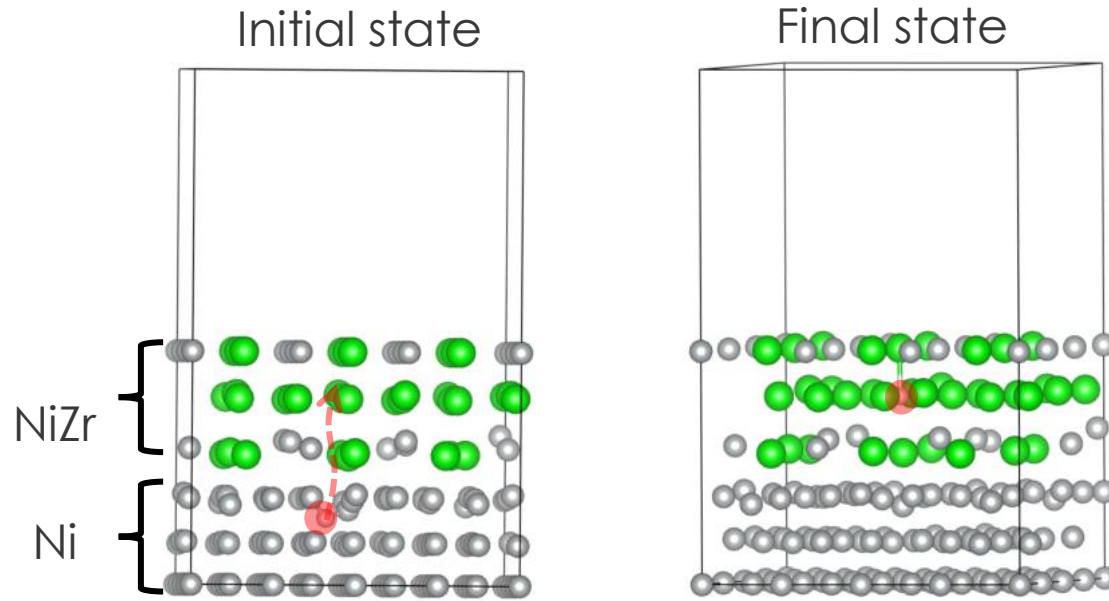
Unirradiated Getter: Transmission Kikuchi Diffraction (TKD) Map of FIB TEM Foil from OD.

Note the complexity of the interface.

Thanks to Dan Edwards and Josh Silverstein.

Ni-Ni₁Zr₃ Interface Model

Diffusion of ³H Across Ni- Ni₁Zr₃ Interface

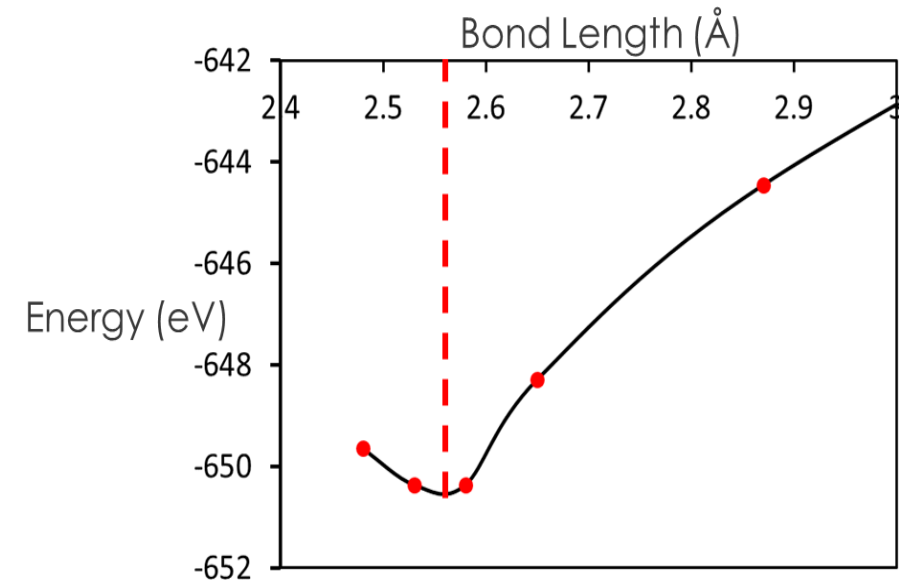
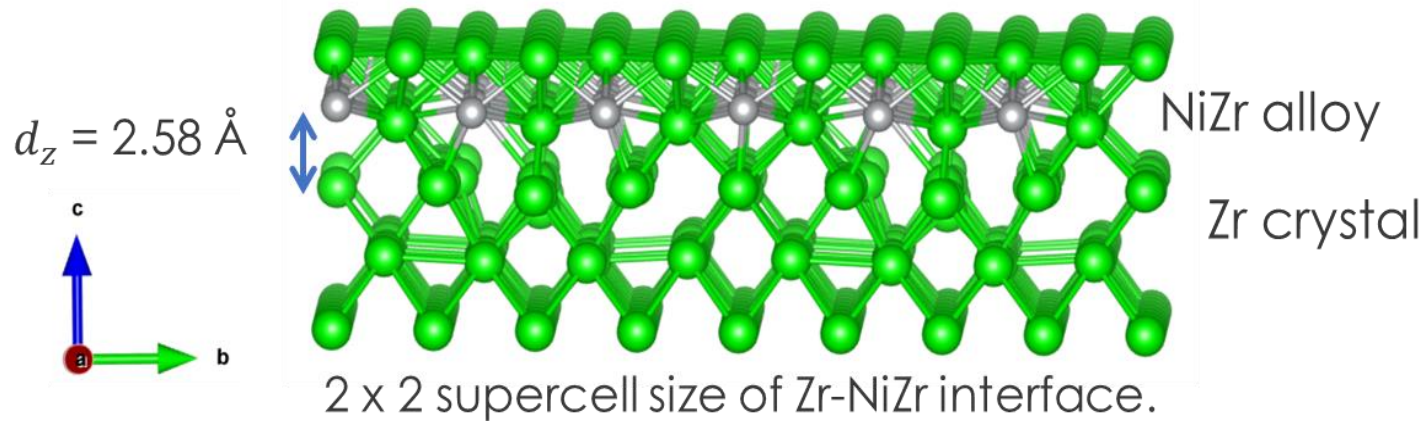
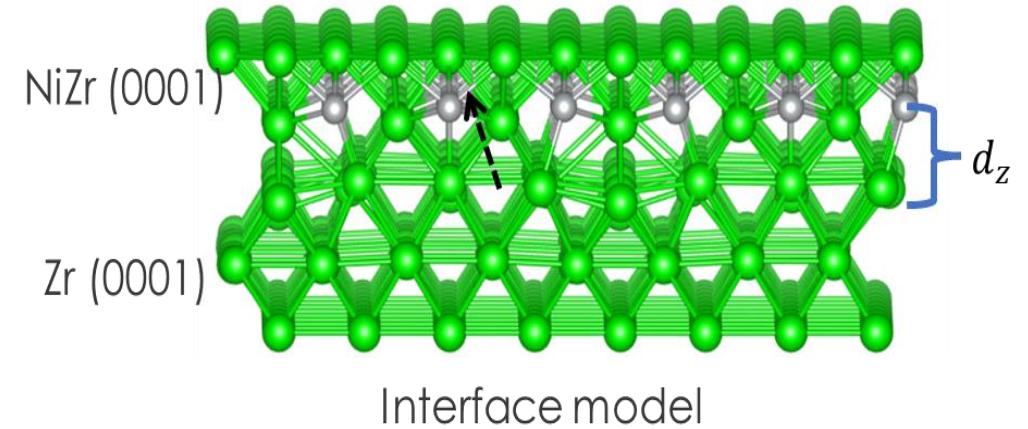


Final state energy is higher than initial state by nearly 1.2 eV; T formation at Ni₁Zr₃ side is higher than Ni side.

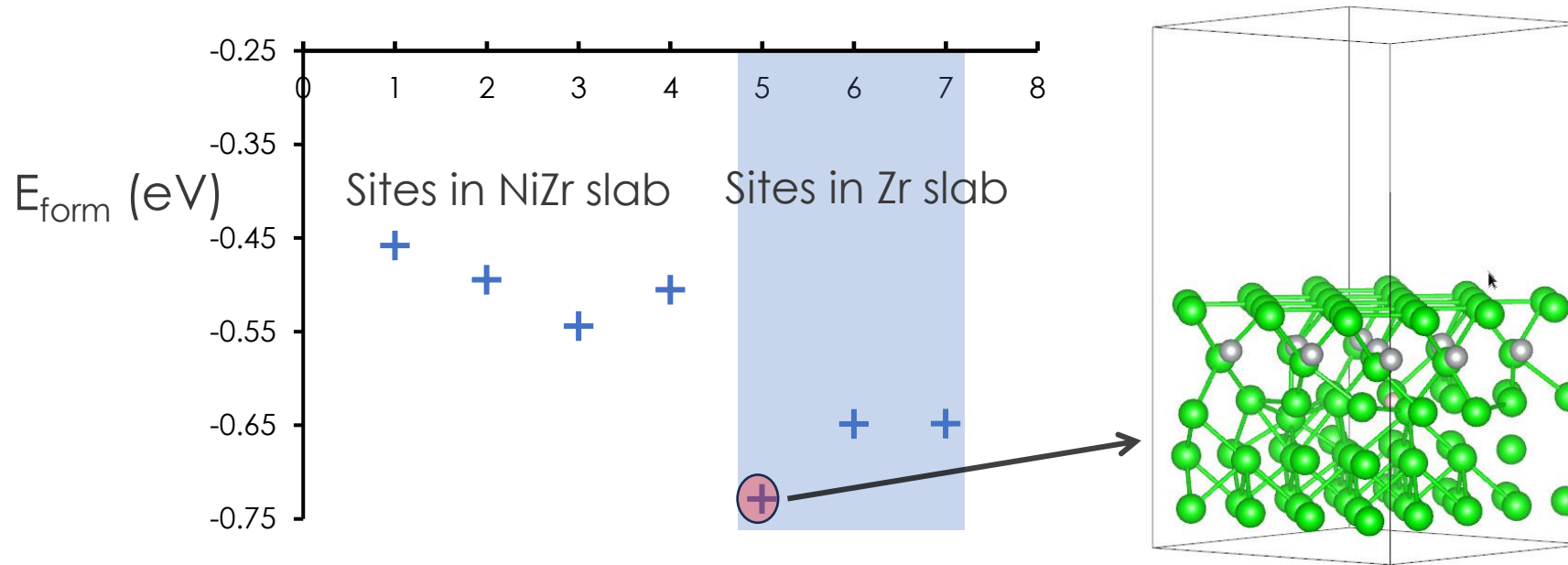
Modelling of Zr- Ni₁Zr₃ Interface: Calculation Steps

Calculation Steps

- Optimize Ni/NiZr/Zr interface.
- Calculate the diffusion barriers across the alloy interface for ³H.
- Introduce Sn impurity and vacancies.
- Calculate the diffusion barriers for ³H in the presence of impurities and vacancies, and without Sn impurity and vacancies.

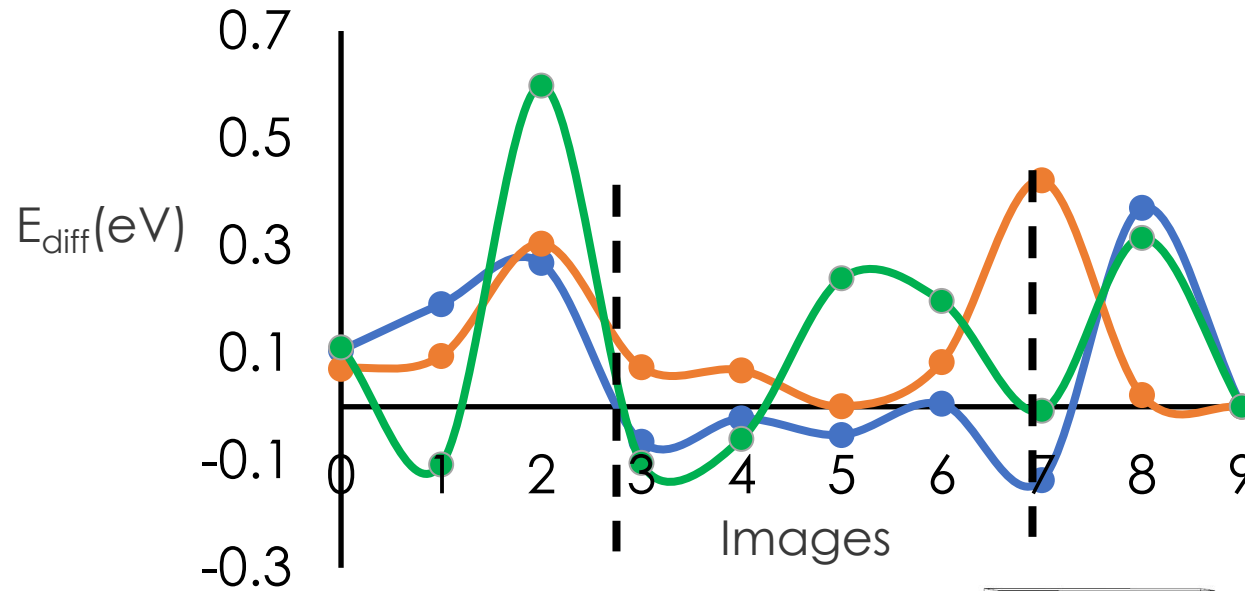


T Optimization in Zr-Ni₁Zr₃ Interface



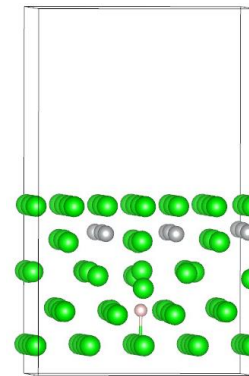
T formation was found to be relatively higher in the Zr slab. This leads to T to diffuse with no barrier on the Zr side of the interface.

T Diffusion Across Zr-Ni₁Zr₃ Interface

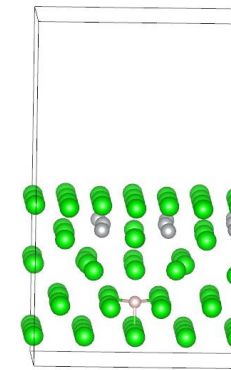


Pure interface
With Zr vacancy
With Sn impurity

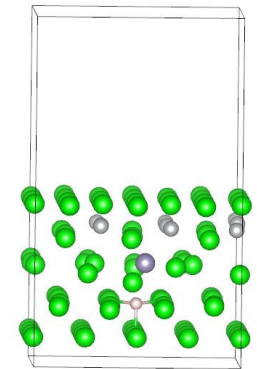
- In pure interface and one with Sn impurity interface, T is found to have trapping barrier.
- This result is consistent with the T trapping at the interface found in pure interface model.
(D. Tafen et al' 2024)



Pure interface



With Zr vacancy



With Sn impurity

- ❖ Our predicted $^3\text{H}_2$ and $^3\text{H}_2\text{O}$ molecules from $\gamma\text{-LiAlO}_2$ pellet verify the experimental findings. The dominated product is $^2\text{H}_2$.
- ❖ The $^3\text{H}_2$ and $^3\text{H}_2\text{O}$ will be dissociated on the surface of Ni and diffuse into subsurface. It's likely the Ni-O could be formed, indicates NiO_x & $\text{Ni}(\text{O}^3\text{H})_x$ phase could be formed, Only ^3H diffused into getter to form metal hydrides (Zr^3H_x).
- ❖ ^3H can be easily diffused through Ni(111)/Zr(0001) interface. Sn & O present could hinder ^3H diffusion.
- ❖ More complicated Ni/ NiZr_x /Zr interface models were built. The complete ^3H diffusion pathways across these interfaces were calculated. The effects of impurities and defect along the ^3H diffusion path were investigated.
 - The minimum Ni-Zr bond length in each interface was fully optimized and was found to be 2.58 Å for Zr/ Ni_1Zr_3 and 2.19 Å for Ni/ Ni_1Zr_3 .
 - The T diffusion barriers in Zr/ Ni_1Zr_3 were found to be 0.5, 0.42, and 0.62 eV, respectively, in pure interface, with Zr vacancy and with Sn impurity. However, a trapping well of 0.13 eV was found in the Zr/ Ni_1Zr_3 interface with a Sn impurity.
 - The ^3H stability in Ni_1Zr_3 alloy region was found to be higher by more than 1 eV than in Ni system.

Thank You !